



Integrated Device Technology, Inc.
6024 Silver Creek Valley Road, San Jose, CA - 95138

PRODUCT/PROCESS CHANGE NOTICE (PCN)

ATTACHMENT I - PCN # : A1609-02

PCN Type: Manufacturing Site - Alternate Assembly Location

Data Sheet Change: None

No change in moisture sensitivity level (MSL)

Detail Of Change:

This notification is to advise our customers that IDT is adding OSET, Taiwan as an alternate assembly facility for parts that are currently assembled at Amkor Philippines.

The material set details of the current and alternate assembly location is as shown in Table 1.

There is no change to the moisture performance.

Table 1: Assembly Material Sets for The Existing and Alternate Assembly Location

Description	Existing (Amkor Philippines)	Add (OSET, Taiwan)
CABGA-96 (BF96, BFG96)	Die Attach: Ablestik 2300	Ablestik 2300
	Wire: 1.0 mil Gold wire	1.0 mil Gold wire
	Mold Compound: EME-G770	KE-G1250

Qualification Information and Qualification Data:

Affected Packages: CABGA-96

Assembly Material: Shown on page 2 of this attachment.

Qual Plan & Results: Tests are in accordance with JEDEC47 recommended tests.

Qualification Vehicle: CABGA-160

Test Description	Test Method	Test Results (Rej / SS)		
		Lot 1	Lot 2	Lot 3
* Temperature Cycling (-55°C to 125°C, 700 cycles)	JESD22-A104	0/25	0/25	0/25
* HAST - biased (Vccmax, 130 °C/85% RH, 96 Hrs)	JESD22-A110	0/25	0/25	0/25
High Temperature Storage Bake (150°C, 1000 Hrs)	JESD22-A103	0/25	0/25	0/25
Moisture Sensitivity Level, MSL	J-STD-20 / MSL 3, 260 °C	0/25	0/25	-

* Tests were subjected to Preconditioning per JESD22-A113 prior to stress test



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Part Number	Part Number	Part Number	Part Number
74ALVCH32244BFG	74SSTUBF32866BBFG	74ALVCH32245BFG8	SSTUA32864BHLFT
SSTUA32864BHLF	74LVCH32245ABFG8	74ALVCH32245BFG	
74SSTUBF32866BBFG8	74LVCH32245ABFG	74ALVCH32244BFG8	